

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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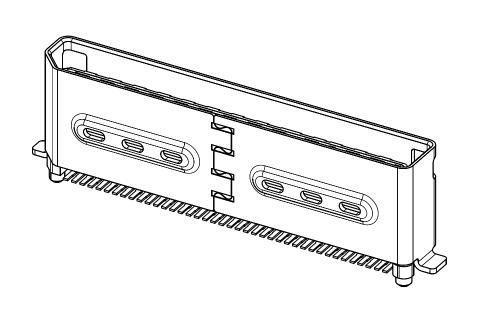
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







	12	11	11			9			
		MATERIAL	GND T	TERMINAL	PICK AN	ND PLACE			
Н	STATUS	NUMBER		OPTION	CA	AP COLOR		DIM 'T'	
	TOOLED	173162-0331		SMT		N/A		N/A	
	TOOLED	173162-0332		TAIL		N/A		3.00	
	TOOLED	173162-0333		SMT		BLACK		N/A	
	TOOLED	173162-0334		TAIL		BLACK		3.00	
	NOT TOOLED	173162-0335		TAIL		BLACK		2.36	
	NOT TOOLED	173162-0336		TAIL		BLACK		1.57	
	TOOLED	173162-0338		XD		BLACK		3.00	
	NOT TOOLED	173162-0339		XD		BLACK		2.36	
	NOT TOOLED	173162-0340		XD		BLACK		1.57	
G									





NOTES:

1. MATERIALS:

HOUSING - GLASS FILLED THERMOPLASTIC, 94V-0 CONTACTS - HIGH PERFORMANCE COPPER ALLOY SHIELD - STAINLESS STEEL

2. FINISH:

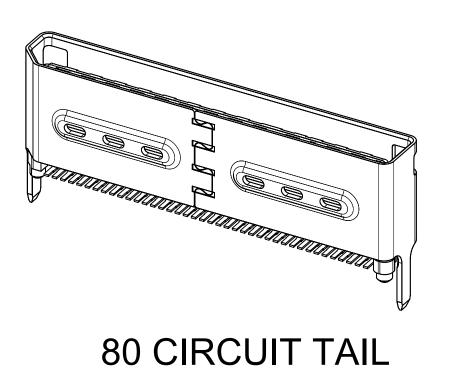
CONTACTS - 0.76µm MIN. GOLD MATING SIDE 2.54µm TIN ON SOLDER TAILS 2.0µm MIN. NICKEL UNDERPLATE OVERALL

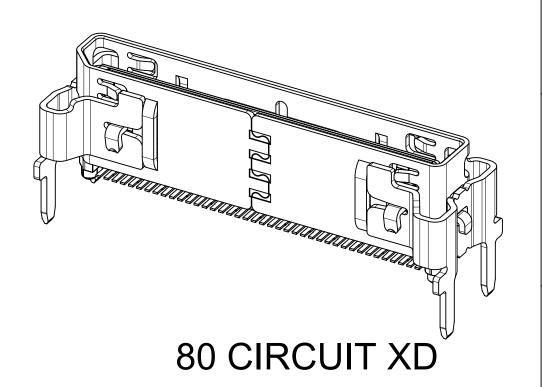
SHIELD - MATTE TIN OVER 1.27µm MIN. NICKEL

- 3. PRODUCT SPECIFICATION: PS-173162-0001
- 4. PACKAGING SPECIFICATION: PK-173307-0001
- 5. MATES WITH: MOLEX CABLE SERIES 200226 OR 200227
 PER INDUSTRY STANDARD PCIe OCuLink 1.0, SFF-8611
- 6. APPLICATION SPECIFICATION: AS-173162-0001

RELEASE STATUS P1 RELEASE DATE 11.11.2017 15:22:50

- 7. COSMETIC SPECIFICATION: PS-45499-002, CLASS B
- 8. DATE CODE TO BE LOCATED APPROXIMATELY AS SHOWN, DATE CODE TO SHOW THE DATE AND YEAR OF ASSEMBLY (DDDYY OR YYDDD)





THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION molex* GENERAL TOLERANCES (UNLESS SPECIFIED) MM ONLY 5:1 201 201 201 DRWN BY INCH MM 4 PLACES **BJANOWIAK** 2015/05/11 NANO PITCH I/O FIXED 25G 3 PLACES CHK'D BY **VERTICAL 8X** 2 PLACES MJANTELEZIO 2015/05/11 1 PLACES ± 0.25 DATE PRODUCT CUSTOMER DRAWING 0 PLACES MBANAKIS 2015/09/18 SERIES MATERIAL NUMBER CUSTOMER ANGULAR TOL \pm 0.5 DRAWING SIZE THIRD ANGLE PROJECTION 173162 SEE CHART **GENERAL MARKET** DRAFT WHERE APPLICABLE DOC TYPE DOC PART SHEET NUMBER MUST REMAIN D WITHIN DIMENSIONS 1 OF 7 SD-173162-0002 PSD 001

